MSKSEMI 美森科













ESD

TVS

TSS

MOV

GDT

PLED

AONS32304

Product specification





Description

The AONS32304 uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

Features

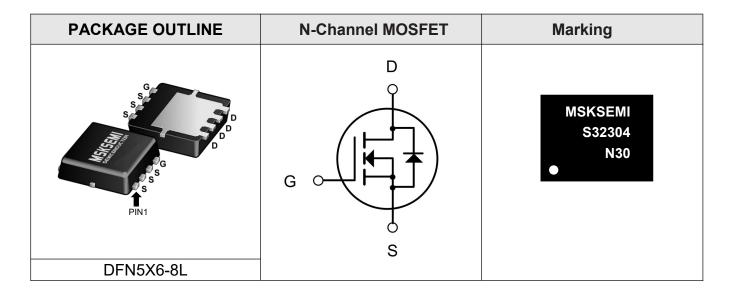
VDS = 30V ID =150A

 $RDS(ON) \le 2.4m\Omega VGS=10V$

Application

Battery protection Load switch Uninterruptible power supply

Reference News



Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units	
Vds	Drain-Source Voltage	30	V	
V _{GS}	Gate- Source Voltage	±20	V	
I⊳ @Tc=25°C	Continuous Drain Current, V GS @ 10V ¹	150	A	
ID @Tc=100°C	Continuous Drain Current, V GS @ 10V 1	80	A	
Ідм	Pulsed Drain Current ²	160	А	
EAS	Single Pulse Avalanche Energy ³	180	mJ	
las	Avalanche Current	60	A	
P _D @T _C =250	Total Power Dissipation ⁴	187	W	
Тѕтс	Storage Temperature Range	-55 to 150	°C	
TJ	TJ Operating Junction Temperature Range		°C	
Reja	Thermal Resistance Junction-Ambient ¹	62	°C/ W	
Rejc	Thermal Resistance Junction-Case ¹	1.1	°C/W	



Electrical Characteristics (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	Vgs=0V , Ib=250uA	30			V
\triangle BV _{DSS} / \triangle T _J	BVDss Temperature Coefficient Reference to 250, ID=1mA			0.014		V/°C
Rds(on)		Vgs=10V , Ib=30A		2	2.4	
	Static Drain-Source On-Resistance ²	Vgs=4.5V , Id=15A		2.5	3.2	mΩ
VGS(th)	Gate Threshold Voltage		1.2		2.5	V
$^{\triangle}V$ GS(th)	V _{GS(th)} Temperature Coefficient	──		-4		Mv/°C
	Drein Source Leekege Current	V _D s=24V , V _G s=0V , T _J =25 [°] C			1	
IDSS	Drain-Source Leakage Current	V _D s=24V , V _G s=0V , T _J =55 [°] C			5	uA
lgss	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance Vos=5V , Io=30A			50		S
Rg	Gate Resistance Vbs=0V, Vgs=0V, f=1MHz			1.7		Ω
Qg	Total Gate Charge (4.5V)			56.9		
Qgs	Gate-Source Charge	Vds=15V , Vgs=10V , Id=15A		13.8		nC
\mathbf{Q}_{gd}	Gate-Drain Charge			23.5		
Td(on)	Turn-On Delay Time			20.1		
Tr	Rise Time	Vdd=15V , Vgs=10V , Rg=3.3Ω,		6.3		
Td(off)	Turn-Off Delay Time	ID=1A		124.6		ns
Tf	Fall Time			15.8		
Ciss	Input Capacitance			4345		
Coss	Output Capacitance	V _D s=15V , V _G s=0V , f=1MHz		340		pF
Crss	Reverse Transfer Capacitance			225		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current ^{1,6}	Vg=VD=0V , Force Current			150	А
Vsd	Diode Forward Voltage ²	Vgs=0V,Is=1A,T」=250			1.2	V

Note :

1. The data tested by surface mounted on a 1 inch₂ FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width \leq 300us , duty cycle $\,\leq\,$ 2%

3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS}=60A

4.The power dissipation is limited by $150^\circ\!\mathrm{C}$ $\,$ junction temperature

5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

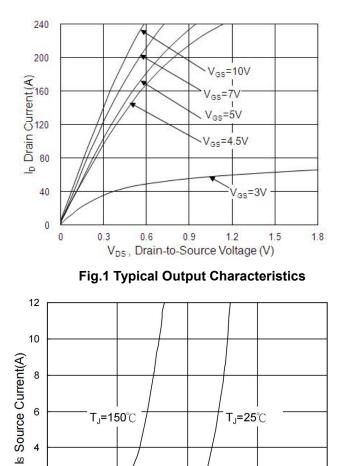
6.Package limitation current is 85A.

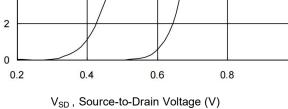


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Typical Characteristics





T_**=25°**℃

1

T**J=150°**℃

Fig. 3 Forward Characteristics of Reverse

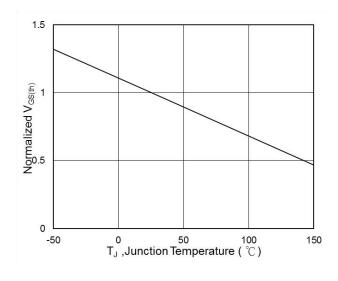


Fig.5 Normalized V_{GS(th)} v.s T_J

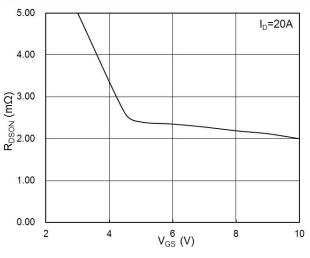
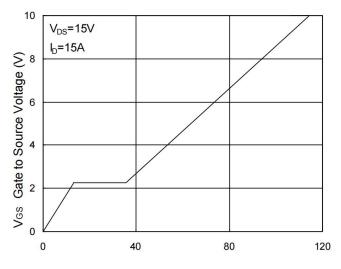


Fig.2 On-Resistance v.s Gate-Source



 Q_G , Total Gate Charge (nC) Fig. 4 Gate-Charge Characteristics

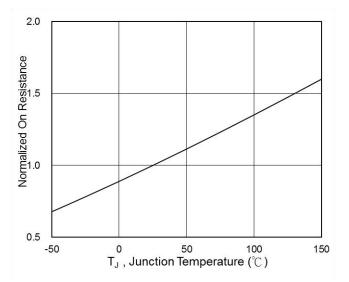


Fig. 6 Normalized RDSON V.S TJ



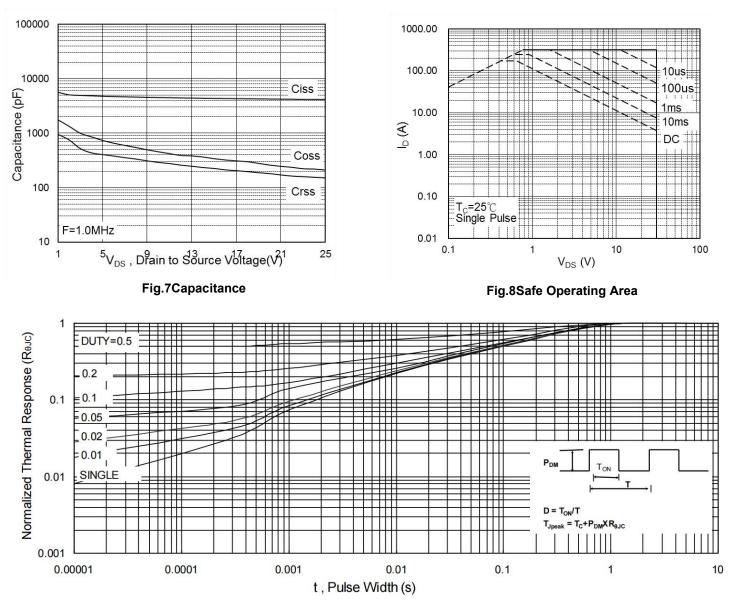


Fig.9 Normalized Maximum Transient Thermal Impedance

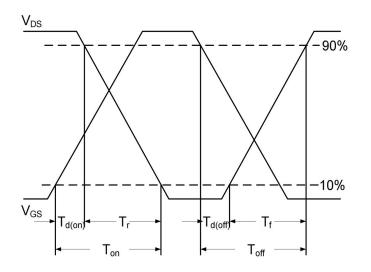


Fig.10 Switching Time Waveform

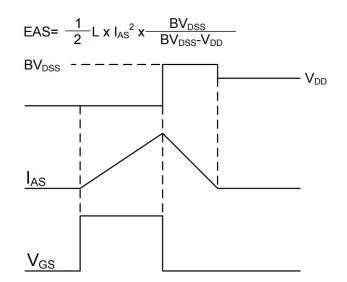
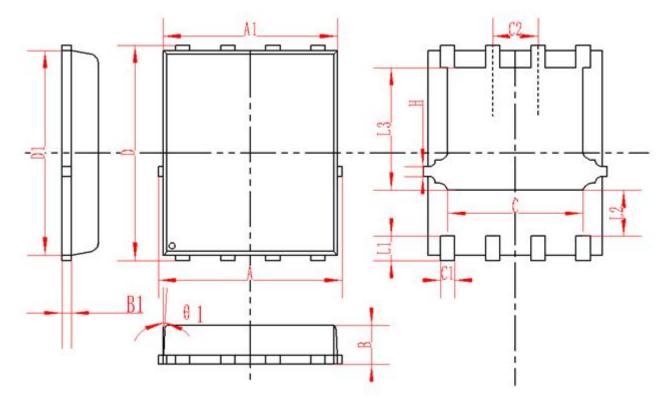


Fig.11 Unclamped Inductive Switching Waveform



DFN5X6-8L Package Information



SYMBOL	MM			INCH		
STIVIDUL	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2	1.27TYP		0.5TYP			
θ1	8.	10.	12 _°	8.	10.	12.
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010

REEL SPECIFICATION

P/N	PKG	QTY
AONS32304	DFN5X6-8L	5000



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